IRPLLED1A

IRPLLED1A 350mA to 1.5A High Voltage LED Driver using IRS25401

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EVALUATION BOARD - IRPLLED1A



1. Introduction

Development of LED technology over the last few years has produced high power devices with luminous efficacies surpassing Fluorescent and HID light sources. These solid state light sources also posses the added advantages of longer operating life span, up to 50000 hours as well greater robustness that other less efficient light sources. For these reasons high power LEDs have now become a viable alternative for many general lighting applications. High power LEDs are driven with constant regulated DC current, requiring a "ballast" or "converter" to provide the required current from an AC or DC power source. The IRS25410/11 series Buck LED driver provides an accurately controlled current and protects the LEDs against damage from overload, while providing the ability to dim the light level. The IRS25401 and IRS25411 are drop in replacements for the IRS2540 and IRS2541, which are not recommended for new designs. The high side level shifting circuitry in the IRS25401/11 has been improved to prevent the possibility of the high side latching up under certain circumstances during dimming.

The IRPLLED1A evaluation board is a high voltage LED driver designed to operate from a DC input voltage of 50V to 170V and produce an output voltage of 16V-24V to supply a programmable load current of 350mA, 700mA, 1A, or 1.5A. It uses the IRS25401/11, a high voltage, high frequency Buck control IC for constant LED current regulation. The IRS25401/11 controls the average load current by a continuous mode time-delayed hysteretic method using an accurate on chip band gap voltage reference. The 8-pin, 200V/600V rated IRS25401/11 inherently provides short-circuit protection with open-circuit protection incorporated by a simple external circuit and has dimming capability.

The evaluation board documentation will briefly describe the functionality of IRS25401/11, discuss the selection of the output stage, switching components and surrounding circuitry. This board was tested with a single HBLED panel for the 350mA and 700mA settings, using two similar flood boards in parallel to provide test loads for the 1A and 1.5A settings.

Important Safety Information

The IRPLLED1A does not provide galvanic isolation of the LED drive output from the line input. Therefore if the system is supplied directly from a non-isolated input, an electrical shock hazard exists at the LED outputs and these should not be touched during operation. Although the output voltage is low this electrical shock hazard still exists.

It is recommended that for laboratory evaluation that the IRPLLED1A board be used with an isolated DC input supply. The IRS25401/11 series Buck topology is suitable only for final applications where isolation is either not necessary or provided elsewhere in the system.

2. Constant current control

The IRS25401/11 is a time-delayed hysteretic Buck controller. During normal operating conditions the output current is regulated via the IFB pin voltage to a nominal value of 500mV. This feedback signal is compared to an internal high precision band gap voltage reference. An on-board dV/dt filter has also been used to prevent erroneous transitioning. This is necessary since the IFB pin is sensitive to noise.

The Buck topology may use a fast recovery diode for the lower switch or a synchronous MOSFET shown as M2 in Fig 1. On power up as the VCC supply to the IRS25401/11 reaches V_{CCUV+} the LO output is held high and the HO output low for a predetermined period of time. This initiates charging of the bootstrap capacitor establishing the VBS floating supply for the high side output. The chip then begins toggling HO and LO outputs as needed to regulate the load current. monitored and fed back through the current sense resistor RCS. The dead times of approximately 140ns between the LO and HO gate drive signals prevents shoot through and reduce switching losses, particularly at higher frequencies.

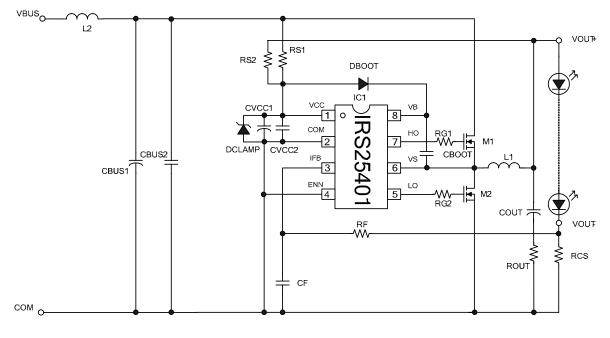


Fig. 1 IRS25401/11 Constant Current LED Driver Typical Schematic (see Fig. 16 for evaluation board full schematic)

Note: Cout and Rout are optional and may be required in some applications

Under normal operating conditions, if VIFB is below VIFBTH, HO will be high and the load receives current from VBUS through the Buck inductor L1. This simultaneously stores energy in the output stage comprised of L1 and COUT as VIFB begins to increase. When VIFB crosses VIFBTH, HO transitions low after the delay t_HO_off. Once HO is low, LO will transition high after the dead time. The inductor and output capacitor release the stored energy into the load and VIFB starts decreasing. When VIFB crosses VIFBTH again, LO switches low after the

delay t LO off and HO switches high after the delay t HO on. The cycle then repeats continuously at a frequency depending on the load current and the values of the output inductor and capacitor.

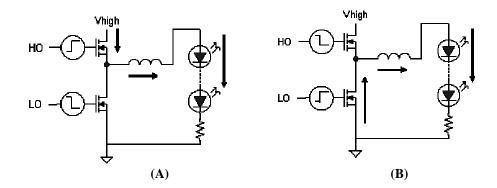


Fig. 2 (A) Storing Energy in Inductor (B) Releasing Stored Inductor Energy

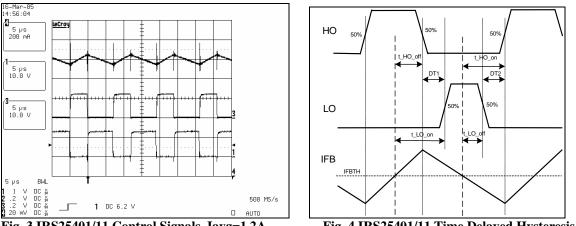
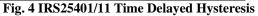


Fig. 3 IRS25401/11 Control Signals, Iavg=1.2A



The switching continues to regulate the current at an average value determined as follows: when the output combination of L1 and COUT is large enough to maintain a low ripple on IFB (less than 100mV), Iout(avg) can be calculated:

$$Iout(avg) = \frac{VIFBTH}{RCS}$$

Having load current programmable from 350mA to 1.5A, series and parallel combinations of resistors must be used to correctly set the current as well as distribute power accordingly. Equivalent resistances for each current setting are calculated as follows:

$$R_{350mA} = \frac{0.5V}{350mA} = 1.43\Omega$$
$$R_{700mA} = \frac{0.5V}{700mA} = 0.71\Omega$$

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$$R_{1A} = \frac{0.5V}{1A} = 0.5\Omega$$
$$R_{1.5A} = \frac{0.5V}{1.5A} = 0.33\Omega$$

Since some of these equivalent values of resistance are not available, series and parallel combinations are used and are specified as follows (all combinations use standard value resistors: 1.43Ω , 0.56Ω , and 0.47Ω):

$$\begin{aligned} R_{350mA} &= 1.43\Omega \\ R_{700mA} &= 0.71\Omega \approx (1.43\Omega \parallel 1.43\Omega) = 0.715\Omega \\ R_{1A} &= 0.5\Omega \approx (0.47\Omega + 0.56\Omega) \parallel (0.47\Omega + 0.56\Omega) = 0.515\Omega \\ R_{1.5A} &= 0.33\Omega \approx (0.47\Omega + 0.56\Omega) \parallel (0.47\Omega + 0.56\Omega) \parallel (0.47\Omega + 0.56\Omega) = 0.343\Omega \end{aligned}$$

Although some of the series and parallel combinations do not yield the exact resistance needed for tolerance purposes, they are accurate enough. For this evaluation board an extremely tight current regulation is achieved with a worst case result of $\pm 1.2\%$ for the 350mA setting over the bus voltage range from 50V to 170V. Likewise a precise regulation of $\pm 0.25\%$ can be maintained for a range of load voltage from 16V to 24V at the 350mA current setting. The jumper positions on the evaluation boards (JSET) for setting the different load currents are shown below:

,			:					
0	σ	00		0	0	0	0	
0	σ	00		0	0	0	0	
0	0	<u>o o</u>		σ	ס	0	0	
0	0	0 0		σ	\circ	0	$\overline{\circ}$	
0	0	0 0		0	0	σ	ס	
1.5A		1A		350mA		: 700mA		

Fig. 4a: JSET LED Current Programming Settings

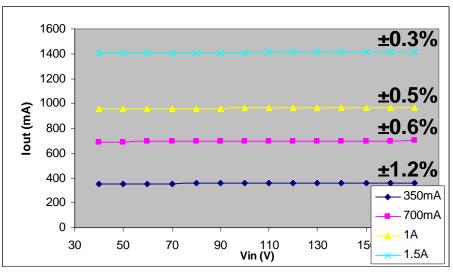


Fig. 5 Vout = 16V, L1 = 470uH, COUT = 33uF

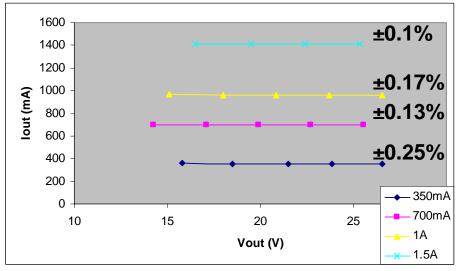


Fig. 6 Vbus = 100V, L1 = 470uH, COUT = 33uF

3. Frequency selection

The frequency in the IRS25401/11 application is free running and maintains current regulation by quickly adapting to changes in input and output voltages. There is no need for additional external components to set the frequency as seen in other controllers. The frequency is determined by L1 and COUT, as well as the input/output voltages and load current. The selection of the frequency is a trade-off between system efficiency, current control regulation, size, and cost.

The higher the frequency, the smaller and lower the cost of L1 and COUT, the higher the ripple, the higher the FET switching losses, which becomes the driving factor as VBUS increases to higher voltages, the higher the component stresses and the harder it is to control the output current.

4. Output L1 and COUT selection

In order to maintain good output current regulation with minimum ripple, the value of L1 needs to be adequately sized. COUT is optional and can also be used for energy storage, which allows the converter to run at a lower frequency. Excess ripple at the output results in high peak currents that are undesirable for driving high power LEDs and also negates the ability of the system to accurately regulate the average current.

First, the effect of the inductor in a configuration with no output capacitor will be considered to clearly demonstrate the impact of the inductor. In this case, the load current is identical to the inductor current. Fig. 7 shows how the inductor value influences the frequency over a range of input voltages. As can be seen, the input voltage also has a great effect on the frequency. The inductor value reduces the frequency for lower input voltages.

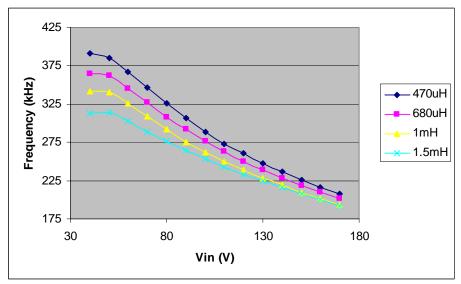


Fig. 7 Iout = 350mA, Vout = 16.8V, COUT = 0uF

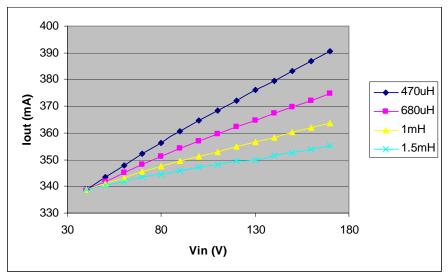


Fig. 8 Iout = 350mA, Vout = 16.8V, COUT = 0uF

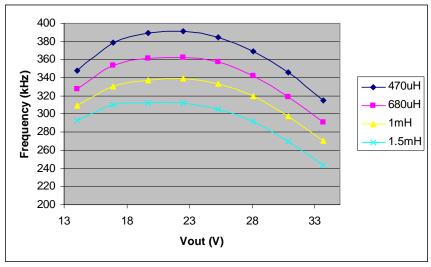


Fig. 9 Iout = 350mA, Vin = 50V, COUT = 0uF

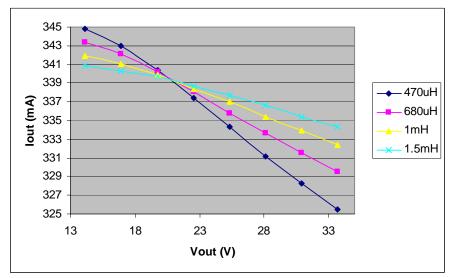


Fig. 10 Iout = 350mA, Vin = 50V, COUT = 0uF

The output capacitor can be used simultaneously to reduce the frequency and improve current control accuracy. Fig. 11 shows how the capacitance reduces the frequency over a range of input voltage. A capacitance of 4.7uF has a large effect on reducing the frequency. Fig. 12 shows how the current regulation is also improved with the output capacitance. There is a point at which continuing to add capacitance no longer has a significant effect on the operating frequency or current regulation, as can be seen in Fig. 12 and Fig. 13.

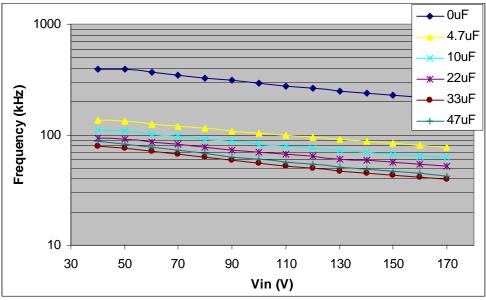


Fig. 11 Iout = 350mA, Vout = 16.8V, L = 470uH

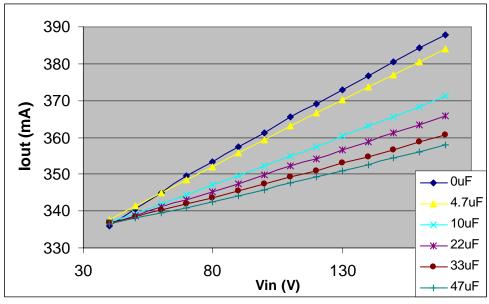


Fig. 12 Iout = 350mA, Vout = 16.8V, L = 470uH

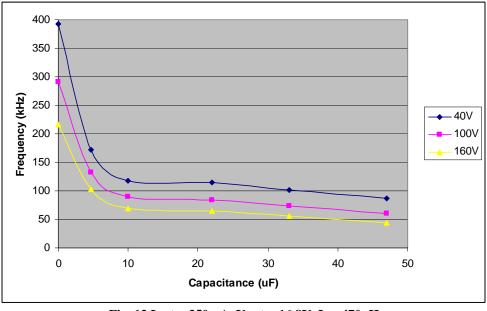


Fig. 13 Iout = 350mA, Vout = 16.8V, L = 470uH

The addition of the COUT is essentially increasing the amount of energy that can be stored in the output stage, which also means it can supply current for an increased period of time. Therefore by slowing down the di/dt transients in the load, the frequency is effectively decreased.

With the COUT capacitor added to the circuit the inductor current is no longer identical to that seen in the load. The inductor current has a triangular shape, where as the load will see the same basic trend in the current, but all sharp corners become rounded with peaks significantly reduced, as can be seen in Fig. 14 and 13.

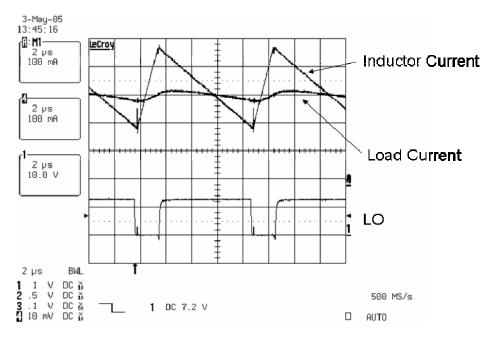


Fig. 14 Iout = 350mA, Vin = 100V, Vout = 16.85V, L = 470uH, COUT = 33uF

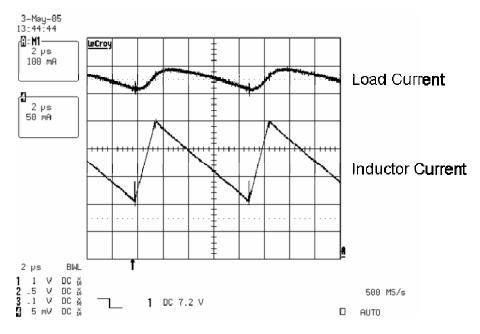


Fig. 15 Iout = 350mA, Vin = 100V, Vout = 16.85V, L = 470uH, COUT = 33uF

Since the system is operating in a free running hysteretic mode, the frequency will adjust to whatever point maintains the regulation of the load current. Since there are fixed delays and a fixed dead time within the IRS25401/11 controller, the current monitored at the IFB input always overshoots the threshold before the system switches from the energy store phase to the energy release phase. The current must also undershoot the threshold before the system mean that the inductor L1 and capacitor COUT (if used) must be selected to maintain a low enough frequency to minimize this overshoot and undershoot. Output ripple is determined by overshoot and undershoot, which become greater as frequency increases.

The inductor for the IRPLLED1A evaluation board was selected to supply the maximum output current of 1.5A. Due to constraints of size a value of 470uH was chosen, which provides good performance. The IRPLLED1A may be used with or without the output capacitor COUT connected. If COUT is not connected the system runs at higher frequency and consequently with reduced efficiency due to switching losses.

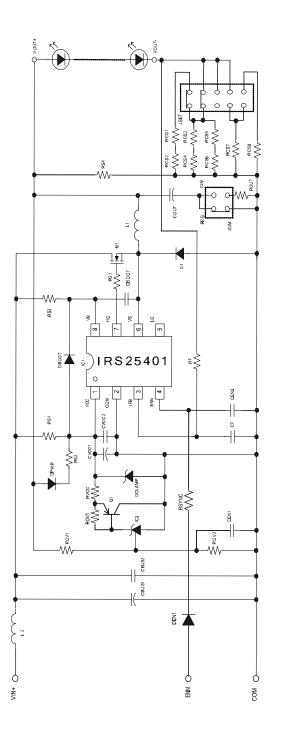
Because of these considerations an inductor of 470uH and an output capacitance of 33uF were chosen to accommodate the 1.5A load current. The current ripple associated with 470uH is relatively small so the board can be operated with or without output capacitance at the lower current ratings.

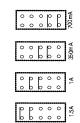
5. MOSFET vs Diode for the low side switch

The IRS25401/11 has been designed so that it can drive a low side MOSFET and a high side MOSFET. Alternatively the low side FET can be replaced by a freewheeling diode as shown in Fig. 16. This may yield a lower cost system, but there are some efficiency tradeoffs to be considered, particularly for higher load currents. The system efficiency is directly influenced by several system parameters including operating frequency, load current, and input voltage.

In this evaluation board a fast recovery power diode is used for the lower switch.

A major parameter to consider is the reverse recovery time of the diode in comparison to the body diode of the FET it replaces. The diode intrinsically has a much shorter reverse recovery time since the device is specifically designed for this, where as the body diode is a parasitic element that originates from basic processing technology and typically has inferior characteristics, in terms of forward drop, reverse recovery, and power handling capabilities.







Note: Rout is needed only in few applications

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If a MOSFET is used for the lower switch, reverse recovery losses are incurred during the dead time after the low side MOSFET has been on and conducting current. During this dead time the low side MOSFET is off, but the body diode is freewheeling and providing current to the load. Since the body diode is conducting current, carriers are present and will eventually need to be recombined leading to reverse recovery delay. When the high side MOSFET turns on the VS node is very rapidly pulled from COM to VBUS and the low side MOSFET or the freewheeling diode conducts current from VS to ground due to the reverse recovery effect resulting in power losses. This can result in overheating of the low side switching component and component stress, as can be seen in Fig. 17 to 18. Since the power diode has a much shorter reverse recovery time the diode will conduct current for a significantly shorter period and exhibit lower power losses. At lower frequency and reduced load current, the long recovery time associated with the MOSFET body diode may not be an issue. For higher frequency higher current applications a diode could provide lower power losses with respect to a MOSFET.

With a low side MOSFET fitted to the IRPLLED1A evaluation board reverse recovery current peaks 8A were measured. This resulted in a temperature rise which could be reduced by replacing the low side MOSFET with an appropriate freewheeling diode. The reverse recovery current peaks were reduced to 4.5A. The frequency was also selected to keep the diode reverse recovery associated power losses low.

With the inclusion of a freewheeling diode instead of a low side MOSFET comes the need for an alternative means of pre-charging the bootstrap capacitor CBOOT at startup. RS3 and RS4 provide a current path from the DC bus to VB and from the output to COM in order to accomplish this. After the IRS25401/11 begins to switch and the high side Buck MOSFET switches off after the first cycle, the voltage at VS transitions to 0V/COM due to the freewheeling action of the lower diode. this allows CBOOT to charge through DBOOT in the normal way and this operation is repeated every cycle. RS4 represents only a small power loss if the output voltage is below 30V, however for higher output voltages a low side MOSFET is necessary.

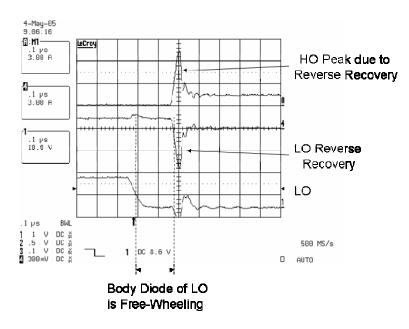


Fig. 17 Using a low side FET, Vin = 100V, Iout = 1.5A, Vout = 17V

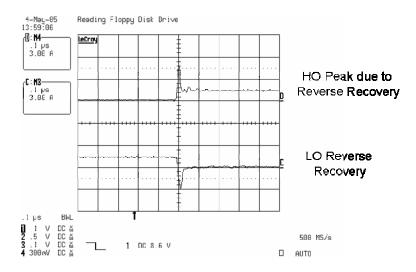


Fig. 18 Using a diode on the low side, Vin = 100V, Iout = 1.5A, Vout = 17V

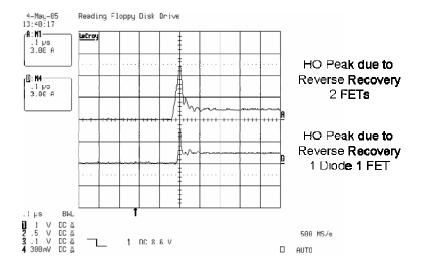


Fig. 19 Low side FET vs. low side diode comparison, Vin = 100V, Iout = 1.5A, Vout = 17V

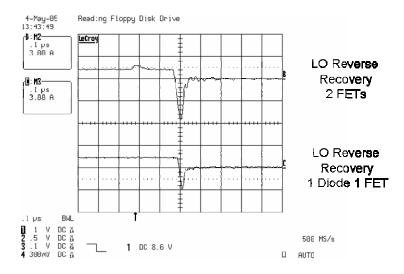


Fig. 20 Low side FET and low side diode comparison, Vin = 100V, Iout = 1.5A, Vout = 17V

Switching losses increase with higher bus voltage. Conduction losses in the lower switch also increase as the difference between input and output voltages increases, since it conducts for a greater part of the switching cycle. A MOSFET has much lower conduction losses than a diode since it has a fixed on resistance and not a fixed junction voltage drop and therefore offers an advantage at higher voltages and currents. A combination of diode and MOSFET together is also a possibility if required. The IRPLLED1A board allows for an additional MOSFET switch M2 to be added. In this case, during the dead time, instead of the body diode freewheeling the additional diode would be conducting. This will always be the case as long as the forward drop of the external diode is less than that of the body diode.

If the load current is the low hundred milliamps range, the losses in the diode may not be a concern. For optimized system efficiency the forward conduction losses of a diode can also be compared to the reverse recovery losses with a low side MOSFET. For this evaluation board, it was found that conduction losses were less than reverse recovery losses when running at 1.5A and therefore and diode alone was used.

Selecting the correct MOSFET involves finding a part with as low an RDSon low as possible. MOSFET RDSon increases for higher VDS rated parts. Therefore, if a 600V MOSFET is used in a 200V application, extra losses may be incurred due to a component that far exceeds the requirements. If using two MOSFETs the next parameter to be considered is the reverse recovery time. Obviously MOSFETs will not have a reverse recovery time comparable to diodes but a reverse recovery time in the order of 150 to 200ns is possible. The two remaining parameters to consider are direct trade-offs of each other, on resistance and gate charge. If the MOSFET has a relatively low gate capacitance the die size will be small, which will result in a larger on resistance that could potentially be a problem for high current applications. On the other hand, if the MOSFET has a larger gate capacitance the die will be relatively large and the part will have a lower on resistance. In this case more current is needed to turn on the MOSFET therefore requiring more VCC current in the IRS25401/11 and resulting in higher losses. There has to be a direct compromise between the two. Typically the best solution is a MOSFET with a relatively low RDSon and a medium sized gate capacitance much like the device chosen for this application.

6. VCC Supply

Since the IRS24501/11 is rated for 200V/600V VBUS can vary considerably in different applications. If a simple supply resistor from VBUS is used for VCC it will experience high power losses at higher bus voltages. For higher voltage applications therefore an alternate V_{CC} supply scheme utilizing a resistor feed-back (RS2) from the output needs to be implemented, as seen in Fig. 1 and Fig. 16. This solution is limited to applications where the LED string voltage exceeds the voltage required to drive VCC, which is about 13V to guarantee good operation.

The resistance between VBUS and V_{CC} (RS1) should be large enough to minimize the current sourced directly from the input voltage line. Through this supply resistor a current will flow to charge the V_{CC} capacitor. Once the capacitor is charged up to the V_{CCUV+} threshold, the IRS25401/11 begins to operate activating the LO and HO outputs. After the first few cycles of switching the resistor RS2 connected between the output and V_{CC} will take over and source current for VCC from the output. The RS2 resistor provided in the evaluation board has been designed for an output of 16 to 24V. If a higher output voltage is desired, RS2 will need to be increased accordingly. Conversely, if the output voltage is below 20V the value of RS2 may need to be reduced in order to supply sufficient voltage to VCC.

A 10uF capacitor has been used at VCC of the IRS2540, which removes most low frequency ripple that could originate from VBUS due to a rectified voltage waveform.

If the input and output voltages are defined for the evaluation board, enough information is provided to calculate values for RS1, RS2, and RS3 (see Fig. 23 for component definition). All three supply resistors were chosen to be 1W devices since they source all current to the chip. Efficiency can be improved by optimizing these values for specific applications.

By making each component 1W, the work in supplying VCC can be split up equally making it a more robust solution instead of relying entirely on one component. This also allows the chip to turn on at a lower bus voltage.

Assuming that a 14V external zener diode will be used on Vcc, exact values of RS1, RS2, and RS3 are calculated as follows (values calculated to operate the components just below half their rated power):

$$P = \frac{V^2}{R}$$

RS1

$$\frac{1}{2}W = \frac{\left(V_{Bus_{\max}} - 14V\right)^2}{RS1}$$

$$RS1 = \frac{(V_{Bus_{\max}} - 14V)^2}{\frac{1}{2}W} = \frac{(170V - 14V)^2}{\frac{1}{2}W}$$

 $RS1 = 48.6k\Omega \approx 56k\Omega$

RS3

min duty ratio $\approx 10\%$

$$\frac{1}{2}W = \frac{(1-0.1)\cdot(V_{Bus_{\max}} - 14V)^2}{RS3}$$

$$RS3 = \frac{(1-0.1) \cdot (V_{Bus_{\max}} - 14V)^2}{\frac{1}{2}W} = \frac{(1-0.1) \cdot (170V - 14V)^2}{\frac{1}{2}W}$$

 $RS1 = 43.8k\Omega \approx 47k\Omega$

RS2

$$\frac{1/2}{2}W = \frac{\left(V_{Out_{max}} - 14V\right)^2}{RS2}$$

$$RS2 = \frac{\left(V_{Out_{max}} - 14V\right)^2}{\frac{1/2}{2}W} = \frac{\left(30V - 14V\right)^2}{\frac{1/2}{2}W}$$

 $RS1=512\Omega\leq 1k\Omega$

RS1 may be rounded up to 1K

7. VBS Supply

The bootstrap diode (DBOOT) and supply capacitor (CBOOT) comprise the supply voltage for the high side driver circuitry. To guarantee that the high-side supply is charged up before operation commences, the first pulse from the output drivers comes from the LO pin. During under voltage lock-out mode, the high and low-side outputs are both held low.

During an open circuit condition, without the watchdog timer, the HO output would remain high at all times and the charge stored in the bootstrap capacitor (CBOOT) would slowly leak until reaching zero, thus eliminating the floating power supply for the high side driver. To maintain sufficient charge on CBOOT, a watchdog timer has been implemented. In the condition where VIFB remains below VIFBTH, the HO output will be forced low roughly after 20µs and the LO output forced high. This toggling of the outputs will last for 1µs to maintain and replenish sufficient charge on CBOOT.

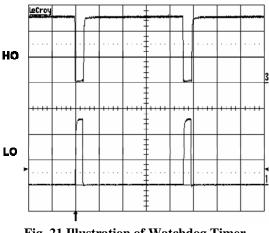


Fig. 21 Illustration of Watchdog Timer

The bootstrap capacitor value needs to be chosen so that it maintains sufficient charge for at least the $20\mu s$ interval until the watchdog timer allows the capacitor to recharge. If the capacitor value is too small, the charge will fully dissipate in less than $20\mu s$. The bootstrap capacitor should be at least 100nF. A larger value within reason can be used if preferred.

The bootstrap diode should be a fast recovery, if not an ultrafast recovery component to maintain good efficiency. Since the cathode of the bootstrap diode will be switching between COM and VBUS + 14V, the reverse recovery time of this diode is of critical importance. For additional information concerning the bootstrap components, refer to the Design Tip (DT 98-2), "*Bootstrap Component Selection For Control ICs*" at <u>www.irf.com</u> under Design Support.

8. Enable Pin

The enable pin can be used for dimming or open-circuit protection. When the ENN pin is held low the IRS25401/11 remains in a fully functional state with no alterations to the operating environment. To disable the control feedback and regulation a voltage greater than VENTH (approximately 2.5V) needs to be applied to the ENN pin. With the chip in a disabled state the HO output will remain low and the LO output will remain high to prevent VS from floating, in addition to maintaining charge on the bootstrap capacitor if a MOSFET is used for the lower switch. The threshold for disabling the IRS25401/11 has been set to 2.5V to enhance immunity to any externally generated noise or application ground noise and also makes it possible receive a drive signal from a microcontroller.

Dimming Mode

To achieve dimming a signal with constant frequency and set duty cycle can be fed into the ENN pin. There is a direct linear relationship between the average load current and duty cycle if no output capacitor is used in the circuit. A large output capacitor tends to increase the minimum dim level because some current continues to supply the LEDs from this capacitor during the off phase of the PWM dimming. With no output capacitor, if the ratio is 50% then 50% of the maximum set light output will be emitted. Similarly if the ratio is 30% then 70% of the maximum set light output will be realized. A sufficiently high frequency of the dimming signal must be chosen to avoid visible flashing or "strobe light" effect. A signal around 1kHz from zero to 5V is recommended.

For this evaluation board, an adjustable (0% to 100% duty cycle) PWM signal generator circuit is suggested. This is not included as part of the evaluation board kit. The following circuit is one of many low cost implementations:

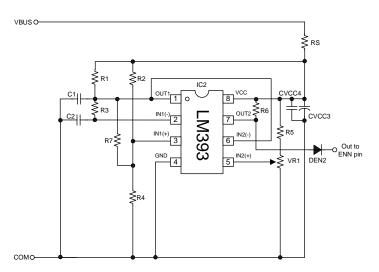


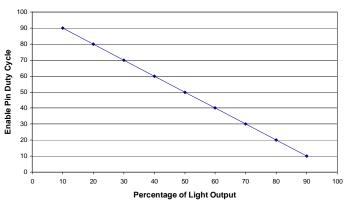
Fig. 22 Suggested PWM Driver (not included in IRPLLED1A kit)

If an external supply for VCC is used, the minimum amount of dimming achievable (light output approaches 0%) will be determined by the "on" time of the HO output, when in a fully functional regulating state. To maintain reliable dimming, it is recommended to keep the "off" time of the enable signal at least 10 times that of the HO "on" time. For example, if the application is running at 75kHz with an input voltage of 100V and an output voltage of

20V, the HO "on" time will be 2.7μ s (one-fourth of the period – see calculations below) according to standard buck topology theory. This will set the minimum "off" time of the enable signal to 27μ s.

$$Duty Cycle = \frac{V_{out}}{V_{in}} * 100 = \frac{20V}{100V} * 100 = 20\%$$
$$HO_{on \text{ time}} = 20\% * \frac{1}{75kHz} = 2.7\,\mu s$$

If the IRS25401/11 is supplied from the output, a large enough capacitor on VCC is required to maintain sufficient current while in a disabled state. For this evaluation board where the IC is supplied from the output a 10uF capacitor is used to ensure continued operation during PWM off periods. The output may drop to 10V and still sustain an adequate VCC supply. A "strobe light" effect in the LEDs may be observed if VCC drops too much or if the dimming frequency is too low.



Enable Duty Cycle Relationship to Light Output

Fig. 23 Light Output vs Enable Pin Duty Cycle

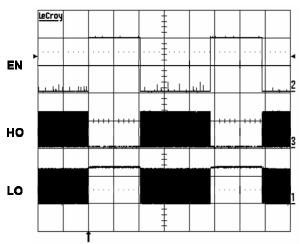


Fig. 24 IRS25401 Dimming Signals

During PWM dimming operation care should be taken to avoid high current pulses occurring in the LED output at the start of each dimming period. This occurs only when a capacitor is connected to the output, that is when the jumper (Jdim) is in the REG position. Although the high side MOSFET is switched off the LED current continues to rise due to resonant action between the output inductor and capacitor. If the jumper is left unconnected in either REG or DIM positions there will be no output capacitor connected and in this case no overshoot occurs at the start of each PWM dimming period. PWM dimming operation therefore should not be used with Jdim in the REG position but instead leave this jumper unconnected or place it in the DIM position. In the DIM position a resistor is added in series with the output capacitor to eliminate the high inrush current and consequent current surge in the LEDs. The presence of high current surges may reduce LED life and cause the inductor to emit audible noise. Figures 25-28 the LED load current and LO pin output at the start of a PWM dimming period to illustrate the behaviour described.. The LO pin output is low when the high side MOSFET is on supplying current to the output.

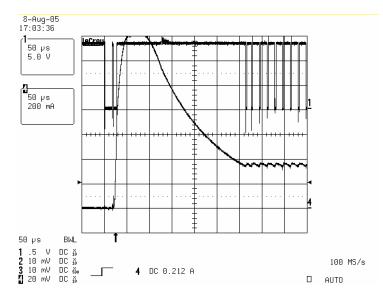


Fig. 25 Load Current Surge dimming with an output capacitor (REG position) Iout = 350mA, Vin = 100V, Vout = 17V

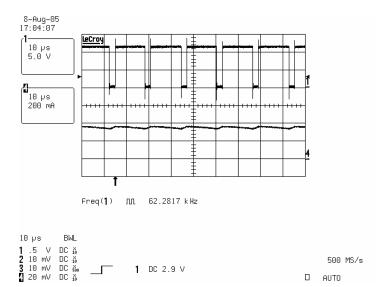


Fig. 26 Load Current Ripple with output capacitor in steady state Iout = 350mA, Vin = 100V, Vout = 17V

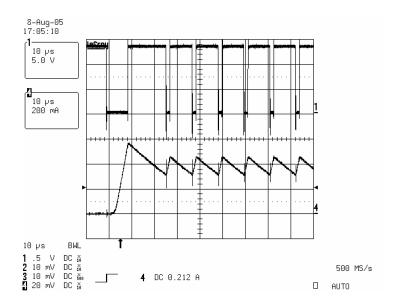


Fig. 27 Load Current Surge including Rout (50hm) in series with output capacitor (DIM position) Iout = 350mA, Vin = 100V, Vout = 17V

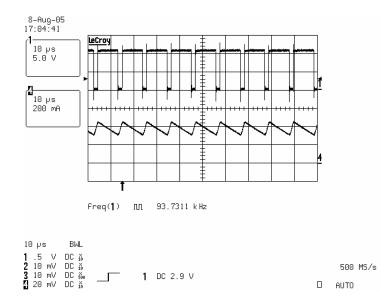
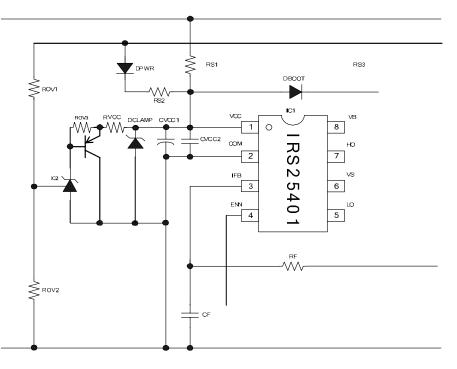


Fig. 28 Load Current Ripple with Rout in series with output capacitor (DIM position) in steady state Iout = 350mA, Vin = 100V, Vout = 17V

Although the inclusion of the resistor Rout minimizes or eliminates the resonant load current surges, the current ripple is increased a little. The resistor reduces the overall effectiveness of the output capacitor, which means the switching frequency will marginally increase. There is a tradeoff between operating frequency and ripple against overshoot during PWM dimming operation to consider. For best possible PWM dimming performance no output capacitor should be used and in this case the frequency is determined by the inductor value. The values of current sense filter RF and CF can be increased to lower the running frequency is a larger output current ripple can be tolerated. An alternative method of achieving the same thing is to add a hysteresis resistor from the LO output to the IFB input. It should be noted that the IRPLLED1A reference design board reflects the schematic of Figure 16 where a high speed diode is used in place of the lower MOSFET switch indicated in Figure 1.



9. Open circuit protection

Fig. 29 IRPLLED1A Improved Open Circuit Protection Scheme

The overvoltage / open-circuit protection circuit shown in Figure 29 replaces schemes used on previous versions of the IRPLLED1A reference design. This method offers far more reliable performance.

The output over voltage / open circuit protection circuit shown in Figure 29 allows the designer to program the allowable maximum output voltage by means of ROV1 and ROV2. An industry standard programmable zener diode type LM431 (IC2) is used to pull down the base of Q1, which pulls down on VCC when the divided voltage from ROV1 and ROV2 exceeds the internal 2.5V reference. IC2 is capable of sinking no more than 100mA and in the SOT-23 package has limited power handling ability, therefore Q1 was added to pull down the VCC voltage fed from RS1 and RS2 to below the under voltage lockout threshold VCCUV- of the IRS25401/11 causing it to shutdown. This circuit reacts very rapidly when the output voltage exceeds the predetermined level. It operates whether or not an output capacitor is connected, i.e. in any of the alternative JDIM jumper positions.

The over voltage protection threshold has been set to 32V in the IRPLLED1A Rev D demo board to allow one or two standard LED panels to be connected in series to the output before reaching a voltage level high enough to trigger the protection circuit. The open circuit protection circuit operates in hiccup mode such that Q1 pulls the VCC voltage below the VCCUV- threshold causing the IRS25401/11 to switch off and enter micro power mode and the output to fall to zero. VCC then charges up again through RS1 until the voltage again exceeds VCCUV+ and the IRS25401/11 starts up again. The sequence then repeats until a load is added to clamp the output voltage.

The above circuit is able to limit the output voltage to a series of pulses instead of a DC level. However it should be noted reducing the average output voltage **does not prevent the possibility of electric shock in non-isolated systems!** Therefore an IRS25401/11 based Buck LED driver running directly off line would still be an electric shock hazard and it would **not** be safe to attempt to replace the LEDs if such a system were powered. In non-isolated systems, additional mechanical protection is required to ensure that access to the LEDs is not possible or alternative

a mechanical isolation system could be used to disconnect the LEDs completely from the ballast for safe access. In an illuminated sign for example, this would be a reasonable approach.

The open circuit protection system described in this section can only be an effective safety feature in a system where the IRS25401/11 Buck stage is used as a back end stage supplied by an already isolated DC source. It does however serve to limit the output voltage to prevent damage to the output capacitor COUT in cases where the bus voltage is greater than the rating of this capacitor.

Note:

The over voltage protection scheme used in the IRPLLED1A evaluation board is different to that used in earlier revisions of the IRPLLED1A and does not conflict with the synchronization operation described in the previous section.

The open load protection circuit in Fig 29 is recommended for isolated non-dimming applications where the load may be disconnected and then reconnected without shutting down the driver. When the load is reconnected with power on this would reduce the initial surge of current to the output reducing stress on the LEDs.

In an open circuit condition, switching will continue at the HO and LO outputs, whether due to the output voltage clamp or to the watchdog timer.

Due to the operation of this circuit the output voltage under open circuit conditions where JDIM is in the DIM position is made up of pulses as shown in Fig 30. If JDIM is in the REG position then these pulses will delay slowly as the output discharges. This can leave an average voltage of approximately 50V at the output. The decay rate of these pulses depends on the value of COUT and the interval between pulses depends on the time taken for CVCC1 to charge above VCCUV- through RS1 and therefore depends on the input voltage.

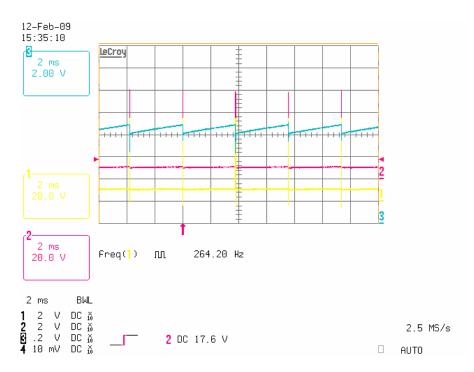


Fig. 30 Open Circuit Fault Signals, with Clamp

The yellow waveform shows the output voltage and the red waveform shows the VS switching waveform. In this example there is no output capacitor. When the output goes above the over voltage threshold the VCC voltage shown in blue is quickly pulled below VCCUV- and then gradually charges back up to VCCUV+ through RS1. If an output capacitor is connected then VCC is pulled almost to zero by IC3 and the systems takes longer to re-start.

$$V_{out} = 2.5 \cdot \frac{\left(R_{OV1} + R_{OV2}\right)}{R_{OV2}}$$

The values of the divider resistor ROV1 and ROV2 are calculated as follows: Let ROV2 = 10K

$$V_{out} = 2.5 \cdot \frac{(R_{OV1} + R_{OV2})}{R_{OV2}}$$

$$R_{OV1} = \frac{V_{out}R_{OV2}}{2.5} - R_{OV2} = \frac{32V \cdot 10k\Omega}{2.5} - 10k\Omega = 118k\Omega$$

 $R_{OV1} \approx 120 k \Omega$

10. Other Design Considerations

<u>Filtering</u>

The RC filter at the IFB pin is used to remove high frequency transients associated with the switching. The corner frequency of this filter was left high enough to prevent any further distortion of the feedback signal.

The input filter is a low-pass filter. Its main objective is to prevent ringing of comparable frequency on Vbus. Exact values of capacitance and inductance are not of critical importance, so long as adequate filtering is accomplished. In addition to the electrolytic capacitor that is used for filtering on the bus there is also a small ceramic for decoupling of high frequency noise. Ceramic capacitors typically have low ESR such that they are more ideal for high frequency filtering.

The IRS25401/11 was specifically designed to handle low frequency ripples on VBUS. Its capability to handle such ripple makes it ideal for an offline rectified waveform. However if high voltage (on the order of 5V-10V) high frequency oscillations (greater than or close to the operating frequency) are present on VBUS, it is recommended to implement an input filter. If these high frequency signals are present on VBUS the IRS25401/11 will still continue to regulate the current through the load, however abnormal switching of LO and HO may be observed. This poses a problem in terms of switching losses. As previously discussed, the application may need to control the operating frequency to optimize the system efficiency. Excessive high frequency ripple at the DC bus could cause the frequency to become unstable, since this system relies on a self-oscillating principle and is sensitive to noise. Careful attention to the PCB layout is also necessary for this system to operate correctly. If filters on IFB and VCC are not placed correctly, high frequency ripple will couple to the IFB input and interfere with the operation of the control loop. Also if the load current is 1A or 1.5A, when HO turns on the load immediately tries to draw this current. Since the circuit supply is not usually close by, the capacitance of the input wire is not enough to compensate for this large pull of current and this can result in oscillations or change in potential on the input line.

To alleviate the circuit of such potential problems it is advisable to implement an input filter. The input filter will also greatly improve the EMC performance.

EMC performance

The IRPLLED1A evaluation board has not been EMC tested. Input and Output filters can be used to reduce the conducted emissions to below the limits of the applicable EMC standard as needed. Inductors may require a powdered Iron core rather than Ferrite, it can handle a much larger current before saturating. If EMC is of critical importance, it may be beneficial to use a MOSFET for the upper switching element and a diode for the lower switch. The reverse recovery time for a diode is inherently shorter than that of a MOSFET and this can help in reducing transients observed in the switching elements resulting in better EMC performance.

Layout Considerations

It is very important when laying out the PCB for the IRS25401/11 based ballast to consider the following points:

- 1. CVCC2 and CF must be as close to IC1 as possible.
- 2. The feedback path should be kept to a minimum without crossing any high frequency lines.
- 3. COUT should be as close to the main inductor as possible.
- 4. All traces that form the nodes VS and VB should be kept as short as possible.
- 5. It is essential that all signal and power grounds should be kept separated from each other to prevent noise from entering the control environment. Signal and power grounds should be connected together at one point only, which must be at the COM pin of the IRS2540. The IRS2540 is very sensitive to noise and will not operate if these guidelines are not followed! It's a general rule of thumb that all components associated with the IC should be connected to the IC ground

with the shortest path possible.

- 6. All traces carrying the load current need to be adjusted accordingly.
- 7. Gate drive traces should also be kept to a minimum.

11. Design Procedure Summary

- 1. Determine the systems requirements: input/output voltage and current needed
- 2. Calculate current sense resistor
- 3. Determine the operating frequency required
- 4. Select L1 and COUT so that they maintain supply into the load during t_HO_on.
- 5. Select switching components (FET/freewheeling diode) to minimize power losses
- 6. Determine VCC and VBS supply components
- 7. Add filtering on the input, IFB and ENN as needed
- 8. Fine tune components to achieve desired system performance

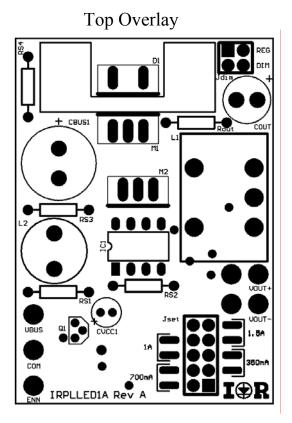
Iype Devices Devices 1 C 100F, 25V, Radial UVZ1E 100MDD Nichicon 1 CVCC1 2 C 100nF, 200V, 1812 V.1812Y104KXCAT BC Components 1 CVCC2 3 C 100nF, 50V, 0805 V.0805Y104KXATW1B BC Components 2 CVCC2, CVCC2, CVCC2, CVCC2, CVCC4 4 C 336F, 100V UVZ2D470MHD Nichicon 1 COUT 5 C 1nF, 50V, 0805 V.0805Y104KXACW1B BC Components 3 CF C EN1, C		_ . D	Of Whater fails				
2 C 100nF, 200V, 1812 VJ805Y104KXATW1B BC Components 1 CBUSC 3 C 100nF, 50V, 0805 VJ0805Y104KXATW1B BC Components 2 CVCC2, CBOOT 4 C 334F, 100V UVZ2A330MPD Nichicon 1 COUT 5 C 1nF, 50V, 0805 VJ0805Y102KXACW1B BC Components 3 CF, CEN1, CF, CEN1, 6 C 470F, 200V UVZ2D470MHD Nichicon 1 CBUS1 7 D 200V, 1A MUR120T3 On Semi 1 DBOTD 9 D 300V, 8A BETH03 IR 1 D1 10 DZ 14V, 0.5W, Mini Melf ZMK5248-7 Diodes Inc 1 DCLAMP 11 L 470uH IL 050 321 31 01 VOGT 1 L1 12 L 470uH RE 10012471 Colicraft 1 L2 13 R 10.0hm, 1%, 0805 MCR1022HF10R0 Rohm 2 RG51, RC </th <th>ltem</th> <th></th> <th>Description</th> <th>Part #</th> <th>Manufacurer</th> <th></th> <th>Reference</th>	ltem		Description	Part #	Manufacurer		Reference
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3 C 100mr, 50, 0005 C 200 percent 2 cBOOT 4 C 33uF, 100V UVZ2A330MPD Nichicon 1 COUT 5 C 1nF, 50V, 0805 VJ0805Y102KXACW1B BC Components 3 CER/2 6 C 47uF, 200V UVZ2D470MHD Nichicon 1 CBUOT 8 D Mini Melf LL4148 Diodes Inc 2 DEN1, DP 9 D 300V, 8A 8ETH03 IR 1 D1 10 DZ 14V, 0.5W, Mini Melf ZMMS2448-7 Diodes Inc 1 DCLAMP 11 L 470uH RD510-471 Coloraft 1 L1 12 L 470uH RFB1010-471 Coloraft 1 L2 14 R 0.56ohm, 1%, 1206 ERJ-8RQFR56V Panasonic 3 RC51, RC 16 R 1.43ohm, 1%, 1206 ERJ-3ENF1203V Panasonic 1 ROV1 19 R<	2	С	100nF, 200V, 1812	VJ1812Y104KXCAT	BC Components	1	CBUS2
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13 R 10ohm, 1%, 0805 MCR10EZHF10R0 Rohm 2 RG1, RG2 14 R 0.56ohm, 1%, 1206 ERJ-8RQFR56V Panasonic 3 RCS2, RC RCS6 15 R 0.47ohm, 1%, 1206 ERJ-8RQFR47V Panasonic 3 RCS1, RC RCS5 16 R 1.43ohm, 1%, 1206 9C12063A1R43FGHFT Yageo 2 RCS7, RC 17 R 100ohm, 1%, 0805 MCR10EZHF1000 Rohm 2 RCS7, RC 18 R 120K, 1%, 1206 ERJ-8ENF1002V Panasonic 1 ROV1 19 R 10K, 1%, 1206 ERJ-8ENF1002V Panasonic 1 ROV2 20 R 3.3K, 5%, 1206 ERJ-8GEYJ332V Panasonic 1 ROV2 21 R 10K, 1%, 5%, 1W 5073NW47K00J12AFX Phoenix Passive 1 RS2 23 R 47K, 5%, 1W 5073NW3K000J12AFX Phoenix Passive 1 RS4 26 R 5 Ohm, 5%, 1W 5073NW5K00J12AFX </td <td>11</td> <td>L</td> <td>470uH</td> <td>IL 050 321 31 01</td> <td>VOGT</td> <td>1</td> <td>L1</td>	11	L	470uH	IL 050 321 31 01	VOGT	1	L1
14 R 0.56ohm, 1%, 1206 ERJ-8RQFR56V Panasonic 3 RCS2, RC RCS6 15 R 0.47ohm, 1%, 1206 ERJ-8RQFR47V Panasonic 3 RCS1, RC RCS5 16 R 1.43ohm, 1%, 1206 ERJ-8RQFR47V Panasonic 3 RCS1, RC RCS5 17 R 1000hm, 1%, 0805 MCR10EZHF1000 Rohm 2 RF, RSYN 18 R 120K, 1%, 1206 ERJ-8ENF1002V Panasonic 1 ROV1 19 R 10K, 1%, 1206 ERJ-8ENF1002V Panasonic 1 ROV2 20 R 3.3K, 5%, 1206 ERJ-8EVJ100V Panasonic 1 ROV3 21 R 10Chm, 5%, 1206 ERJ-8EVJ100V Panasonic 1 RVCC 22 R 1K, 5%, 1W 5073NW47K00J12AFX Phoenix Passive 1 RS1 24 R 56K, 5%, 1W 5073NW56K00J12AFX Phoenix Passive 1 ROUT 25 R 3.3K, 5%, 1W 5073NW3K000J12AFX <td>12</td> <td>L</td> <td>470uH</td> <td>RFB1010-471</td> <td>Coilcraft</td> <td>1</td> <td>L2</td>	12	L	470uH	RFB1010-471	Coilcraft	1	L2
14 R 0.500Hm, 1%, 1206 ERJ-8RQFR5V Panasonic 3 RCS6 15 R 0.47ohm, 1%, 1206 ERJ-8RQFR47V Panasonic 3 RCS1, RC RCS5, RC 16 R 1.43ohm, 1%, 1206 9C12063A1R43FGHFT Yageo 2 RCS7, RC 17 R 100ohm, 1%, 0805 MCR10EZHF1000 Rohm 2 RF, RSYN 18 R 120K, 1%, 1206 ERJ-8ENF1002V Panasonic 1 ROV1 19 R 10K, 1%, 1206 ERJ-8ENF1002V Panasonic 1 ROV2 20 R 3.3K, 5%, 1206 ERJ-8GEYJ302V Panasonic 1 ROV3 21 R 10K, 1%, 1026 ERJ-8GEYJ302V Panasonic 1 ROV3 22 R 1K, 5%, 1W 5073NW1K00J12AFX Phoenix Passive 1 RS2 23 R 47K, 5%, 1W 5073NW56K00J12AFX Phoenix Passive 1 RS1 25 R 3.3K, 5%, 1W 5073NW56K00J12AFX <	13	R	10ohm, 1%, 0805	MCR10EZHF10R0	Rohm	2	RG1, RG2
15 R 0.470m, 1%, 1206 ERJ-BRUPR47V Parasonic 3 RCS5 16 R 1.43ohm, 1%, 1206 9C12063A1R43FGHFT Yageo 2 RCS7, RC 17 R 100ohm, 1%, 0805 MCR10EZHF1000 Rohm 2 RF, RSYN 18 R 120K, 1%, 1206 ERJ-8ENF1003V Panasonic 1 ROV1 19 R 10K, 1%, 1206 ERJ-8EF1002V Panasonic 1 ROV2 20 R 3.3K, 5%, 1206 ERJ-8EYJ302V Panasonic 1 ROV2 21 R 100hm, 5%, 1206 ERJ-8GEYJ332V Panasonic 1 RVC 22 R 1K, 5%, 1W 5073NW1K000J12AFX Phoenix Passive 1 RS2 23 R 47K, 5%, 1W 5073NW3K0600J12AFX Phoenix Passive 1 RS4 26 R 50Kn, 5%, 1W 5073NW3K3000J12AFX Phoenix Passive 1 ROUT 27 IC IRS25401/11 IRS25401/11 IRS2 <td>14</td> <td>R</td> <td>0.56ohm, 1%, 1206</td> <td>ERJ-8RQFR56V</td> <td>Panasonic</td> <td>3</td> <td>RCS2, RCS4, RCS6</td>	14	R	0.56ohm, 1%, 1206	ERJ-8RQFR56V	Panasonic	3	RCS2, RCS4, RCS6
17 R 100ohm, 1%, 0805 MCR10EZHF1000 Rohm 2 RF, RSYN 18 R 120K, 1%, 1206 ERJ-8ENF1203V Panasonic 1 ROV1 19 R 10K, 1%, 1206 ERJ-8ENF1002V Panasonic 1 ROV2 20 R 3.3K, 5%, 1206 ERJ-8GEYJ32V Panasonic 1 ROV3 21 R 100hm, 5%, 1206 ERJ-8GEYJ100V Panasonic 1 RVCC 22 R 1K, 5%, 1206 ERJ-8GEYJ100V Panasonic 1 RVCC 23 R 47K, 5%, 1W 5073NW47K00J12AFX Phoenix Passive 1 RS2 23 R 47K, 5%, 1W 5073NW3500J12AFX Phoenix Passive 1 RS1 25 R 3.3K, 5%, 1W 5073NW5R100J12AFX Phoenix Passive 1 ROUT 27 IC IRS25401/11 IRS25401/11 IR RS2 ROUT 28 Socket 8 Pin DIP 2-641260-1 Amp 1 <td>15</td> <td>R</td> <td>0.47ohm, 1%, 1206</td> <td>ERJ-8RQFR47V</td> <td>Panasonic</td> <td>3</td> <td>RCS1, RCS3, RCS5</td>	15	R	0.47ohm, 1%, 1206	ERJ-8RQFR47V	Panasonic	3	RCS1, RCS3, RCS5
18 R 120K, 1%, 1206 ERJ-8ENF1203V Panasonic 1 ROV1 19 R 10K, 1%, 1206 ERJ-8ENF1002V Panasonic 1 ROV2 20 R 3.3K, 5%, 1206 ERJ-8GEYJ322V Panasonic 1 ROV2 21 R 100hm, 5%, 1206 ERJ-8GEYJ322V Panasonic 1 RVCC 22 R 1K, 5%, 1W 5073NW1K000J12AFX Phoenix Passive 1 RS2 23 R 47K, 5%, 1W 5073NW47K00J12AFX Phoenix Passive 1 RS3 24 R 56K, 5%, 1W 5073NW3K3000J12AFX Phoenix Passive 1 RS1 25 R 3.3K, 5%, 1W 5073NW5R100J12AFX Phoenix Passive 1 ROUT 27 IC IRS25401/11 IRS25401/11 IR 1 In Socket 28 Socket 8 Pin DIP 2-641260-1 Amp 1 IC1 29 IC LM431, SOT-23 LM431BIM3N1C National Semi	16	R	1.43ohm, 1%, 1206	9C12063A1R43FGHFT	Yageo	2	RCS7, RCS8
19 R 10K, 1%, 1206 ERJ-8ENF1002V Panasonic 1 ROV2 20 R 3.3K, 5%, 1206 ERJ-8GEYJ332V Panasonic 1 ROV3 21 R 100hm, 5%, 1206 ERJ-8GEYJ332V Panasonic 1 RVCC 22 R 1K, 5%, 1W 5073NW1K000J12AFX Phoenix Passive 1 RS2 23 R 47K, 5%, 1W 5073NW47K00J12AFX Phoenix Passive 1 RS3 24 R 56K, 5%, 1W 5073NW3K3000J12AFX Phoenix Passive 1 RS1 25 R 3.3K, 5%, 1W 5073NW3K3000J12AFX Phoenix Passive 1 RS1 26 R 5 Ohm, 5%, 1W 5073NW3K3000J12AFX Phoenix Passive 1 ROUT 27 IC IRS25401/11 IRS25401/11 IR 1 In Socket 28 Socket 8 Pin DIP 2-641260-1 Amp 1 IC1 29 IC LM431, SOT-23 LM431BIM3N1C National Sem	17	R	100ohm, 1%, 0805	MCR10EZHF1000	Rohm	2	RF, RSYNC
20 R 3.3K, 5%, 1206 ERJ-8GEYJ332V Panasonic 1 ROV3 21 R 100hm, 5%, 1206 ERJ-8GEYJ100V Panasonic 1 RVCC 22 R 1K, 5%, 1W 5073NW1K000J12AFX Phoenix Passive 1 RS2 23 R 47K, 5%, 1W 5073NW47K00J12AFX Phoenix Passive 1 RS3 24 R 56K, 5%, 1W 5073NW3K3000J12AFX Phoenix Passive 1 RS1 25 R 3.3K, 5%, 1W 5073NW3K3000J12AFX Phoenix Passive 1 RS1 26 R 5 Ohm, 5%, 1W 5073NW3K3000J12AFX Phoenix Passive 1 ROUT 27 IC IRS25401/11 IRS25401/11 IR 1 In Socket 28 Socket 8 Pin DIP 2-641260-1 Amp 1 IC1 29 IC LM431, SOT-23 LM431BIM3N1C National Semi 1 IC2 30 Q PN2907A, TO-92 PN2907A Fairchild	18	R	120K, 1%, 1206	ERJ-8ENF1203V	Panasonic	1	ROV1
21 R 100hm, 5%, 1206 ERJ-8GEYJ100V Panasonic 1 RVCC 22 R 1K, 5%, 1W 5073NW1K000J12AFX Phoenix Passive 1 RS2 23 R 47K, 5%, 1W 5073NW47K00J12AFX Phoenix Passive 1 RS3 24 R 56K, 5%, 1W 5073NW56K00J12AFX Phoenix Passive 1 RS1 25 R 3.3K, 5%, 1W 5073NW5R100J12AFX Phoenix Passive 1 RS4 26 R 5 Ohm, 5%, 1W 5073NW5R100J12AFX Phoenix Passive 1 ROUT 27 IC IRS25401/11 IRS25401/11 IR 1 In Socket 28 Socket 8 Pin DIP 2-641260-1 Amp 1 IC1 29 IC LM431, SOT-23 LM431BIM3N1C National Semi 1 IC2 30 Q PN2907A, TO-92 PN2907A Fairchild 1 Q1 31 M 200V, 16A, TO-220 IRFB17N20D IR <td< td=""><td>19</td><td>R</td><td>10K, 1%, 1206</td><td>ERJ-8ENF1002V</td><td>Panasonic</td><td>1</td><td>ROV2</td></td<>	19	R	10K, 1%, 1206	ERJ-8ENF1002V	Panasonic	1	ROV2
22 R 1K, 5%, 1W 5073NW1K000J12AFX Phoenix Passive 1 RS2 23 R 47K, 5%, 1W 5073NW47K00J12AFX Phoenix Passive 1 RS3 24 R 56K, 5%, 1W 5073NW56K00J12AFX Phoenix Passive 1 RS1 25 R 3.3K, 5%, 1W 5073NW3K3000J12AFX Phoenix Passive 1 RS4 26 R 5 Ohm, 5%, 1W 5073NW3K100J12AFX Phoenix Passive 1 ROUT 27 IC IRS25401/11 IRS25401/11 IR 1 In Socket 28 Socket 8 Pin DIP 2-641260-1 Amp 1 IC2 29 IC LM431, SOT-23 LM431BIM3N1C National Semi 1 IC2 30 Q PN2907A, TO-92 PN2907A Fairchild 1 Q1 31 M 200V, 16A, TO-220 IRFB17N20D IR 1 M1 32 T PC Compact, lack 5009 Keystone 2	20	R	3.3K, 5%, 1206	ERJ-8GEYJ332V	Panasonic	1	ROV3
23 R 47K, 5%, 1W 5073NW47K00J12AFX Phoenix Passive 1 RS3 24 R 56K, 5%, 1W 5073NW56K00J12AFX Phoenix Passive 1 RS1 25 R 3.3K, 5%, 1W 5073NW56K00J12AFX Phoenix Passive 1 RS1 26 R 5 Ohm, 5%, 1W 5073NW5R100J12AFX Phoenix Passive 1 ROUT 27 IC IRS25401/11 IRS25401/11 IR 1 In Socket 28 Socket 8 Pin DIP 2-641260-1 Amp 1 IC1 29 IC LM431, SOT-23 LM431BIM3N1C National Semi 1 IC2 30 Q PN2907A, TO-92 PN2907A Fairchild 1 Q1 31 M 200V, 16A, TO-220 IRFB17N20D IR 1 M1 32 T PC Compact, red 5005 Keystone 2 T1, T4 33 T PC Compact, S009 Keystone 1 T3 <tr< td=""><td>21</td><td>R</td><td>10Ohm, 5%, 1206</td><td>ERJ-8GEYJ100V</td><td>Panasonic</td><td>1</td><td>RVCC</td></tr<>	21	R	10Ohm, 5%, 1206	ERJ-8GEYJ100V	Panasonic	1	RVCC
24 R 56K, 5%, 1W 5073NW56K00J12AFX Phoenix Passive 1 RS1 25 R 3.3K, 5%, 1W 5073NW3K3000J12AFX Phoenix Passive 1 RS4 26 R 5 Ohm, 5%, 1W 5073NW5R100J12AFX Phoenix Passive 1 ROUT 27 IC IRS25401/11 IRS25401/11 IR 1 In Socket 28 Socket 8 Pin DIP 2-641260-1 Amp 1 IC1 29 IC LM431, SOT-23 LM431BIM3N1C National Semi 1 IC2 30 Q PN2907A, TO-92 PN2907A Fairchild 1 Q1 31 M 200V, 16A, TO-220 IRFB17N20D IR 1 M1 32 T PC Compact, red 5005 Keystone 2 T1, T4 33 T PC Compact, black 5006 Keystone 1 T3 35 H Heatsink 7-340-1PP-BA IERC 1 1	22	R	1K, 5%, 1W	5073NW1K000J12AFX	Phoenix Passive	1	RS2
25 R 3.3K, 5%, 1W 5073NW3K3000J12AFX Phoenix Passive 1 RS4 26 R 5 Ohm, 5%, 1W 5073NW5R100J12AFX Phoenix Passive 1 ROUT 27 IC IRS25401/11 IRS25401/11 IR 1 In Socket 28 Socket 8 Pin DIP 2-641260-1 Amp 1 IC1 29 IC LM431, SOT-23 LM431BIM3N1C National Semi 1 IC2 30 Q PN2907A, TO-92 PN2907A Fairchild 1 Q1 31 M 200V, 16A, TO-220 IRFB17N20D IR 1 M1 32 T PC Compact, red 5005 Keystone 2 T1, T4 33 T PC Compact, black 5006 Keystone 1 T3 34 T PC Compact, yellow 5009 Keystone 1 T3 35 H Heatsink 7-340-1PP-BA IERC 1 1 <	23	R	47K, 5%, 1W	5073NW47K00J12AFX	Phoenix Passive	1	RS3
26 R 5 Ohm, 5%, 1W 5073NW5R100J12AFX Phoenix Passive 1 ROUT 27 IC IRS25401/11 IRS25401/11 IR 1 In Socket 28 Socket 8 Pin DIP 2-641260-1 Amp 1 IC1 29 IC LM431, SOT-23 LM431BIM3N1C National Semi 1 IC2 30 Q PN2907A, TO-92 PN2907A Fairchild 1 Q1 31 M 200V, 16A, TO-220 IRFB17N20D IR 1 M1 32 T PC Compact, red 5005 Keystone 2 T1, T4 33 T PC Compact, black 5006 Keystone 1 T3 34 T PC Compact, yellow 5009 Keystone 1 T3 35 H Heatsink 7-340-1PP-BA IERC 1 1 36 B PCB IRPLLED1A Rev D 1 1 3 37 J <td>24</td> <td>R</td> <td>56K, 5%, 1W</td> <td>5073NW56K00J12AFX</td> <td>Phoenix Passive</td> <td>1</td> <td>RS1</td>	24	R	56K, 5%, 1W	5073NW56K00J12AFX	Phoenix Passive	1	RS1
27 IC IRS25401/11 IRS25401/11 IR 1 In Socket 28 Socket 8 Pin DIP 2-641260-1 Amp 1 IC1 29 IC LM431, SOT-23 LM431BIM3N1C National Semi 1 IC2 30 Q PN2907A, TO-92 PN2907A Fairchild 1 Q1 31 M 200V, 16A, TO-220 IRFB17N20D IR 1 M1 32 T PC Compact, red 5005 Keystone 2 T1, T4 33 T PC Compact, black 5006 Keystone 1 T3 34 T PC Compact, yellow 5009 Keystone 1 T3 35 H Heatsink 7-340-1PP-BA IERC 1 1 36 B PCB IRPLLED1A Rev D 1 1 Jame 37 J Jumper, 10 Pos. 929836-09-02-ND 3M 1 Jdim 38 J	25	R	3.3K, 5%, 1W	5073NW3K3000J12AFX	Phoenix Passive	1	RS4
28 Socket 8 Pin DIP 2-641260-1 Amp 1 IC1 29 IC LM431, SOT-23 LM431BIM3N1C National Semi 1 IC2 30 Q PN2907A, TO-92 PN2907A Fairchild 1 Q1 31 M 200V, 16A, TO-220 IRFB17N20D IR 1 M1 32 T PC Compact, red 5005 Keystone 2 T1, T4 33 T PC Compact, black 5006 Keystone 2 T2, T5 34 T PC Compact, yellow 5009 Keystone 1 T3 35 H Heatsink 7-340-1PP-BA IERC 1 1 36 B PCB IRPLLED1A Rev D 1 1 3 37 J Jumper, 10 Pos. 929836-09-02-ND 3M 1 Jset 38 J Jumper, 2 Pos. 929836-09-02-ND 3M 1 Jdim 39 SJ	26	R	5 Ohm, 5%, 1W	5073NW5R100J12AFX	Phoenix Passive	1	ROUT
29 IC LM431, SOT-23 LM431BIM3N1C National Semi 1 IC2 30 Q PN2907A, TO-92 PN2907A Fairchild 1 Q1 31 M 200V, 16A, TO-220 IRFB17N20D IR 1 M1 32 T PC Compact, red 5005 Keystone 2 T1, T4 33 T PC Compact, black 5006 Keystone 2 T2, T5 34 T PC Compact, yellow 5009 Keystone 1 T3 35 H Heatsink 7-340-1PP-BA IERC 1 1 36 B PCB IRPLLED1A Rev D 1 1 3 37 J Jumper, 10 Pos. 929836-09-02-ND 3M 1 Jset 38 J Jumper, 2 Pos. 929836-09-02-ND 3M 1 Jdim 39 SJ Shorting Jumper STC02SYAN Sullins Connectors 3 40 D <td< td=""><td>27</td><td>IC</td><td>IRS25401/11</td><td>IRS25401/11</td><td>IR</td><td>1</td><td>In Socket</td></td<>	27	IC	IRS25401/11	IRS25401/11	IR	1	In Socket
30 Q PN2907A, TO-92 PN2907A Fairchild 1 Q1 31 M 200V, 16A, TO-220 IRFB17N20D IR 1 M1 32 T PC Compact, red 5005 Keystone 2 T1, T4 33 T PC Compact, black 5006 Keystone 2 T2, T5 34 T PC Compact, yellow 5009 Keystone 1 T3 35 H Heatsink 7-340-1PP-BA IERC 1 1 36 B PCB IRPLLED1A Rev D 1 1 Jatest 37 J Jumper, 10 Pos. 929836-09-02-ND 3M 1 Jset 38 J Jumper, 2 Pos. 929836-09-02-ND 3M 1 Jdim 39 SJ Shorting Jumper STC02SYAN Sullins Connectors 3 40 D Not Fitted M2 M2 41 R Not Fitted RIFB	28	Socket	8 Pin DIP	2-641260-1	Amp	1	IC1
31 M 200V, 16A, TO-220 IRFB17N20D IR 1 M1 32 T PC Compact, red 5005 Keystone 2 T1, T4 33 T PC Compact, black 5006 Keystone 2 T2, T5 34 T PC Compact, yellow 5009 Keystone 1 T3 35 H Heatsink 7-340-1PP-BA IERC 1 1 36 B PCB IRPLLED1A Rev D 1 1 1 37 J Jumper, 10 Pos. 929836-09-05-ND 3M 1 Jset 38 J Jumper, 2 Pos. 929836-09-02-ND 3M 1 Jdim 39 SJ Shorting Jumper STC02SYAN Sullins Connectors 3 40 D Not Fitted IRIFB M2 M2 41 R Not Fitted IRIFB M2 M2 43 TH TO-220 Insulating Thermal Pad SP600-54 <td< td=""><td>29</td><td>IC</td><td>LM431, SOT-23</td><td>LM431BIM3N1C</td><td>National Semi</td><td>1</td><td>IC2</td></td<>	29	IC	LM431, SOT-23	LM431BIM3N1C	National Semi	1	IC2
32 T PC Compact, red 5005 Keystone 2 T1, T4 33 T PC Compact, black 5006 Keystone 2 T2, T5 34 T PC Compact, yellow 5009 Keystone 1 T3 35 H Heatsink 7-340-1PP-BA IERC 1 1 36 B PCB IRPLLED1A Rev D 1 1 1 37 J Jumper, 10 Pos. 929836-09-05-ND 3M 1 Jset 38 J Jumper, 2 Pos. 929836-09-02-ND 3M 1 Jdim 39 SJ Shorting Jumper STC02SYAN Sullins Connectors 3 40 D Not Fitted DIFB 41 R Not Fitted RIFB 42 M Not Fitted M2 43 TH TO-220 Insulating Thermal Pad SP600-54 Berquist 2	30	Q	PN2907A, TO-92	PN2907A	Fairchild	1	Q1
33TPC Compact, black5006Keystone2T2, T534TPC Compact, yellow5009Keystone1T335HHeatsink7-340-1PP-BAIERC1136BPCBIRPLLED1A Rev D1137JJumper, 10 Pos.929836-09-05-ND3M1Jset38JJumper, 2 Pos.929836-09-02-ND3M1Jdim39SJShorting JumperSTC02SYANSullins Connectors340DNot FittedDIFB41RNot FittedM243THTO-220 Insulating Thermal PadSP600-54Berquist2	31	М	200V, 16A, TO-220	IRFB17N20D	IR	1	M1
34 T PC Compact, yellow 5009 Keystone 1 T3 35 H Heatsink 7-340-1PP-BA IERC 1 1 36 B PCB IRPLLED1A Rev D 1 1 1 37 J Jumper, 10 Pos. 929836-09-05-ND 3M 1 Jset 38 J Jumper, 2 Pos. 929836-09-02-ND 3M 1 Jdim 39 SJ Shorting Jumper STC02SYAN Sullins Connectors 3 40 D Not Fitted DIFB 41 R Not Fitted MIFB 42 M Not Fitted M2 43 TH TO-220 Insulating Thermal Pad SP600-54 Berquist 2	32	Т	PC Compact, red	5005	Keystone	2	T1, T4
35HHeatsink7-340-1PP-BAIERC136BPCBIRPLLED1A Rev D1137JJumper, 10 Pos.929836-09-05-ND3M1Jset38JJumper, 2 Pos.929836-09-02-ND3M1Jdim39SJShorting JumperSTC02SYANSullins Connectors340DNot FittedDIFB41RNot FittedRIFB42MNot FittedM243THTO-220 Insulating Thermal PadSP600-54Berquist2			PC Compact, black	5006		2	
35HHeatsink7-340-1PP-BAIERC136BPCBIRPLLED1A Rev D137JJumper, 10 Pos.929836-09-05-ND3M138JJumper, 2 Pos.929836-09-02-ND3M139SJShorting JumperSTC02SYANSullins Connectors340DNot FittedDIFB41RNot FittedRIFB42MNot FittedM243THTO-220 Insulating Thermal PadSP600-54Berquist2	34	Т	PC Compact, yellow	5009	Keystone	1	T3
37 J Jumper, 10 Pos. 929836-09-05-ND 3M 1 Jset 38 J Jumper, 2 Pos. 929836-09-02-ND 3M 1 Jdim 39 SJ Shorting Jumper STC02SYAN Sullins Connectors 3 40 D Not Fitted DIFB 41 R Not Fitted RIFB 42 M Not Fitted M2 43 TH TO-220 Insulating Thermal Pad SP600-54 Berquist 2	35	Н	Heatsink	7-340-1PP-BA		1	
38JJumper, 2 Pos.929836-09-02-ND3M1Jdim39SJShorting JumperSTC02SYANSullins Connectors340DNot FittedDIFB41RNot FittedRIFB42MNot FittedM243THTO-220 Insulating Thermal PadSP600-54Berquist2	36	В	PCB	IRPLLED1A Rev D		1	
39SJShorting JumperSTC02SYANSullins Connectors340DNot FittedDIFB41RNot FittedRIFB42MNot FittedM243THTO-220 Insulating Thermal PadSP600-54Berquist2	37	J	Jumper, 10 Pos.	929836-09-05-ND	3M	1	Jset
40DNot FittedDIFB41RNot FittedRIFB42MNot FittedM243THTO-220 Insulating Thermal PadSP600-54Berquist2	38	J	Jumper, 2 Pos.	929836-09-02-ND	3M	1	Jdim
41RNot FittedRIFB42MNot FittedM243THTO-220 Insulating Thermal PadSP600-54Berquist2	39	SJ	Shorting Jumper	STC02SYAN	Sullins Connectors	3	
42MNot FittedM243THTO-220 Insulating Thermal PadSP600-54Berquist2	40	D	Not Fitted				DIFB
43 TH TO-220 Insulating Thermal Pad SP600-54 Berquist 2	41		Not Fitted				RIFB
43 TH Thermal Pad SP600-54 Berquist 2	42	М					M2
44 W Shoulder Washer 3049 Berguist 2	43	TH		SP600-54	Berquist	2	
	44	W	Shoulder Washer	3049	Berquist	2	
45 SC Screw, 4-40, 0.5", Zinc H346-ND Building Fasteners 1	45	SC	Screw, 4-40, 0.5", Zinc	H346-ND	Building Fasteners	1	
46 N Nut, 4-40, Hex, Zinc H216-ND Building Fasteners 1	46	Ν	Nut, 4-40, Hex, Zinc	H216-ND	Building Fasteners	1	

12. Bill of Materials

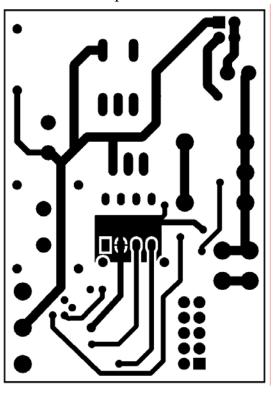
Item	Device Type	Description	Part #	Manufacurer	# of devices	Reference
1	С	10uF, 25V, Radial	ECEA1EKG100	Panasonic	1	CVCC3
2	С	100nF, 50V, 0805	VJ0805Y104KXATW1BC	BC Components	1	CVCC4
3	С	1nF, 50V, 0805	VJ0805Y102KXACW1BC	BC Components	2	C1, C2
4	D	Mini Melf	LL4148	Diodes Inc	1	DEN2
5	R	1k, 1%, 0805	MRC10EZHF1001	Rohm	1	R6
6	R	6.8k, 1%, 0805	MRC10EZHF6801	Rohm	1	R5
7	R	10k, 1%, 0805	MRC10EZHF1002	Rohm	1	R4
8	R	20k	MRC10EZHF2002	Rohm	1	R2
9	R	75k	MRC10EZHF7502	Rohm	2	R1, R3
10	R	Select depending on VBUS		Rohm	1	RS
11	R	56k	MRC10EZHF5602	Rohm	1	R7
12	POT	10k, 10-turn	M64W103KB40	BC Components	1	VR1
13	IC	Comparator	LM393D	Texas Instruments	1	In Socket
14	Socket	8 Pin DIP	2-641260-1	Amp Tyco Electronics	1	IC2
15						

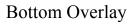
Enable Signal Generator (not included)

13. PCB Layout

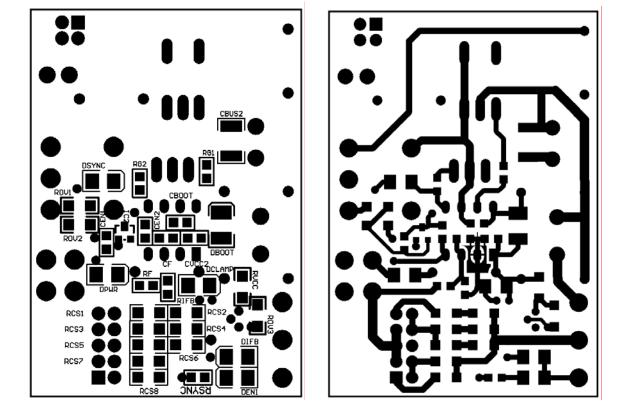


Top Metal





Bottom Metal



IR WORLD HEADQUARTERS: 101 N. Sepulveda Blvd., El Segundo, California 90245 Tel: (310) 252-7105 Data and specifications subject to change without notice. 11/04/2011